

News Release

31st October 2017

The patent infringement lawsuit filed by SEMICAPS against Hamamatsu in California has been held in abeyance pending an inter partes review (IPR) filed by Hamamatsu against US Patent 7,623,982. The IPR was filed with the USPTO in September 2017.

SEMICAPS will rigorously defend the IPR action and the company is confident that the relevant claims of the patent that are involved in the patent infringement lawsuit will survive the IPR.

For more details, visit

[Inter Partes Review of U.S. Pat. 7623982](#)

About SEMICAPS

SEMICAPS is the world's most technologically advanced company in the field of failure localization analysis in semiconductors. Used by leading companies like GlobalFoundries, AMD and Intel for their design-debug and yield analyses, the SEMICAPS laser probe microscope is capable for semiconductor technology nodes as small as 10 nm. Further, besides the standard laboratory configurations, the SEMICAPS Wafer Probing platform, the SEMICAPS 5000, allows semiconductor wafer of complex logic chips to be analysed without the need for sorting, dicing and packaging. This saves weeks for foundries undergoing their yield enhancement cycle.

SEMICAPS, founded in 1988, is a technology spinoff from the National University of Singapore.